

Hyperfast Rectifier, 15 A FRED Pt® G5


D²PAK 2L (TO-263AB 2L)


FEATURES

- Best in class forward voltage drop and switching losses trade off
- Optimized for high speed operation
- 175 °C maximum operating junction temperature
- Polyimide passivation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 245 °C
- Designed and qualified according to JEDEC®-JESD 47
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912


RoHS
 COMPLIANT
 HALOGEN
FREE

LINKS TO ADDITIONAL RESOURCES



| PRIMARY CHARACTERISTICS | |
|--------------------------|------------------------|
| $I_{F(AV)}$ | 15 A |
| V_R | 600 V |
| V_F at I_F at 125 °C | 1.3 V |
| t_{rr} (typ.) | 19 ns |
| T_J max. | 175 °C |
| Package | D²PAK 2L (TO-263AB 2L) |
| Circuit configuration | Single |

DESCRIPTION / APPLICATIONS

Featuring a unique combination of low conduction and switching losses, this rectifier is the right choice for soft switched and resonant converters, as well as medium frequency hard switching converters. This device is specifically designed to improve efficiency of high speed LLC output rectification stages of EV / HEV battery charging stations and high frequency stages of UPS applications

MECHANICAL DATA

Case: D²PAK 2L (TO-263AB 2L)

Molding compound meets UL 94 V-0 flammability rating

Terminals: matte tin plated leads, solderable per J-STD-002

| ABSOLUTE MAXIMUM RATINGS | | | | |
|--|----------------|--|-------------|-------|
| PARAMETER | SYMBOL | TEST CONDITIONS | VALUES | UNITS |
| Repetitive peak reverse voltage | V_{RRM} | | 600 | V |
| Average rectified forward current | $I_{F(AV)}$ | $T_C = 129\text{ °C}$, $D = 0.50$ | 15 | A |
| Repetitive peak forward current | I_{FRM} | $T_C = 129\text{ °C}$, $D = 0.50$, $f = 20\text{ kHz}$ | 30 | |
| Non-repetitive peak surge current | I_{FSM} | $T_C = 25\text{ °C}$, $t_p = 10\text{ ms}$, sine wave | 185 | |
| Operating junction and storage temperature | T_J, T_{Stg} | | -55 to +175 | °C |

| ELECTRICAL SPECIFICATIONS ($T_J = 25\text{ °C}$ unless otherwise specified) | | | | | | |
|--|------------------|---|------|------|------|---------------|
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS |
| Breakdown voltage, blocking voltage | V_{BR} , V_R | $I_R = 100\text{ }\mu\text{A}$ | 600 | - | - | V |
| Forward voltage | V_F | $I_F = 15\text{ A}$ | - | 1.6 | 2.1 | |
| | | $I_F = 15\text{ A}$, $T_J = 125\text{ °C}$ | - | 1.3 | - | |
| Reverse leakage current | I_R | $V_R = V_R$ rated | - | - | 10 | μA |
| | | $T_J = 125\text{ °C}$, $V_R = V_R$ rated | - | - | 500 | |
| Junction capacitance | C_T | $V_R = 200\text{ V}$ | - | 25 | - | pF |
| Series inductance | L_S | Measured to lead 5 mm from package body | - | 8 | - | nH |



| DYNAMIC RECOVERY CHARACTERISTICS (T _J = 25 °C unless otherwise specified) | | | | | | | |
|--|-------------------|---|--|------|------|------|-------|
| PARAMETER | SYMBOL | TEST CONDITIONS | | MIN. | TYP. | MAX. | UNITS |
| Reverse recovery time | t _{rr} | I _F = 1.0 A, di _F /dt = 100 A/μs, V _R = 30 V | | - | 19 | - | ns |
| | | T _J = 25 °C | I _F = 10 A di _F /dt = 1000 A/μs V _R = 400 V | - | 23 | - | |
| | | T _J = 125 °C | | - | 36 | - | |
| Peak recovery current | I _R RM | T _J = 25 °C | I _F = 10 A di _F /dt = 1000 A/μs V _R = 400 V | - | 12 | - | A |
| | | T _J = 125 °C | | - | 20 | - | |
| Reverse recovery charge | Q _{rr} | T _J = 25 °C | I _F = 10 A di _F /dt = 1000 A/μs V _R = 400 V | - | 180 | - | nC |
| | | T _J = 125 °C | | - | 472 | - | |
| Reverse recovery time | t _{rr} | T _J = 25 °C | I _F = 15 A di _F /dt = 1000 A/μs V _R = 400 V | - | 33 | - | ns |
| | | T _J = 125 °C | | - | 44 | - | |
| Peak recovery current | I _R RM | T _J = 25 °C | I _F = 15 A di _F /dt = 1000 A/μs V _R = 400 V | - | 13 | - | A |
| | | T _J = 125 °C | | - | 21 | - | |
| Reverse recovery charge | Q _{rr} | T _J = 25 °C | I _F = 15 A di _F /dt = 1000 A/μs V _R = 400 V | - | 220 | - | nC |
| | | T _J = 125 °C | | - | 578 | - | |

| THERMAL - MECHANICAL SPECIFICATIONS | | | | | | |
|--|-----------------------------------|---|-----------|------|------|-------|
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS |
| Thermal resistance, junction-to-case | R _{thJC} | | - | - | 1.72 | °C/W |
| Weight | | | - | 2.0 | - | g |
| Maximum junction and storage temperature range | T _J , T _{Stg} | | -55 | - | 175 | °C |
| Marking device | | Case style D ² PAK 2L (TO-263AB 2L) | E5TX1506S | | | |

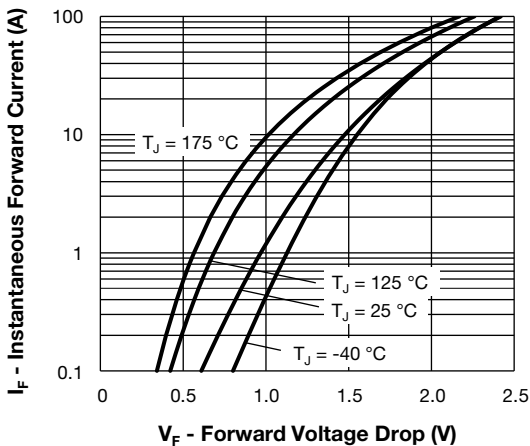


Fig. 1 - Forward Voltage Drop Characteristics, Per Leg

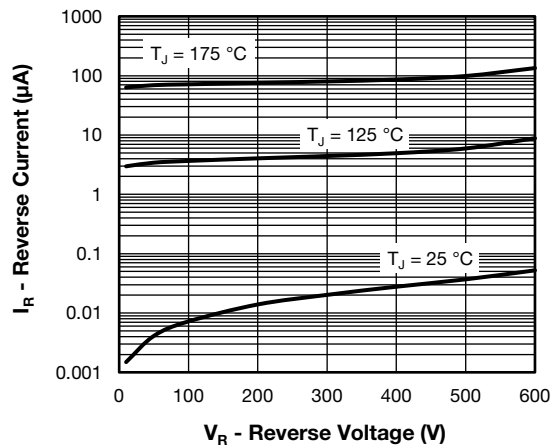


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage, Per Leg

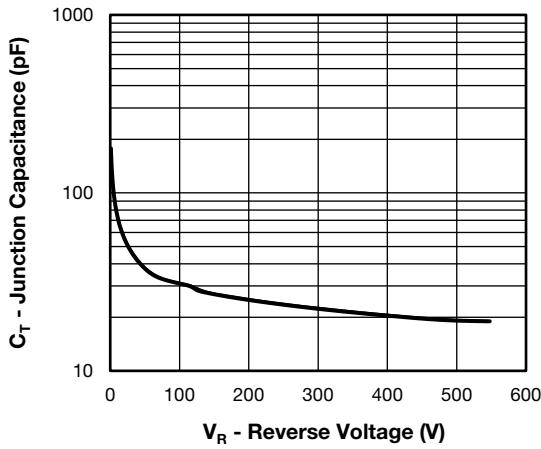


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage, Per Leg

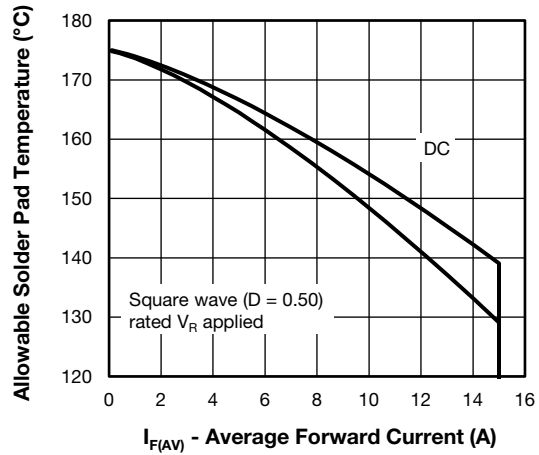


Fig. 4 - Maximum Allowable Case Temperature vs. Average Forward Current, Per Leg

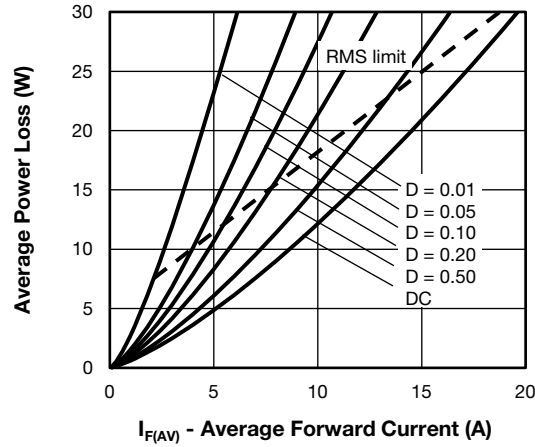


Fig. 5 - Forward Power Loss Characteristics, Per Leg

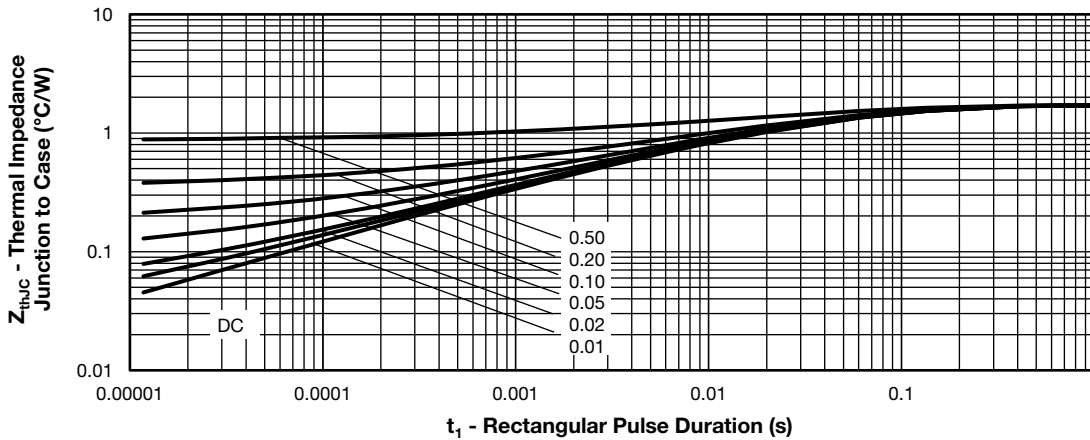


Fig. 6 - Transient Thermal Impedance, Junction to Case, Per Leg

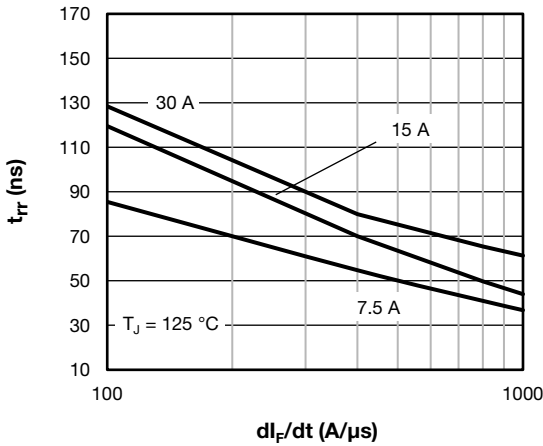


Fig. 7 - Typical Reverse Recovery Time vs. dI_F/dt , Per Leg

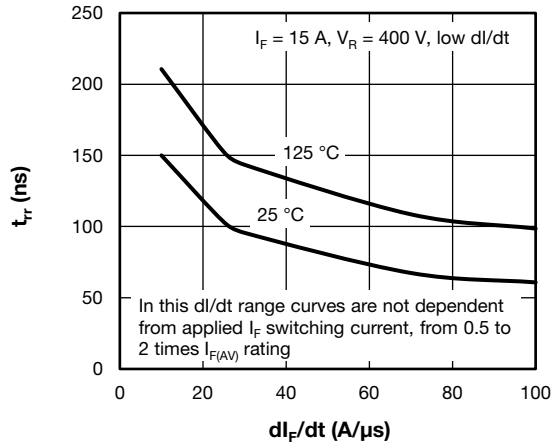


Fig. 10 - Typical Reverse Recovery Time vs. dI_F/dt , Per Leg

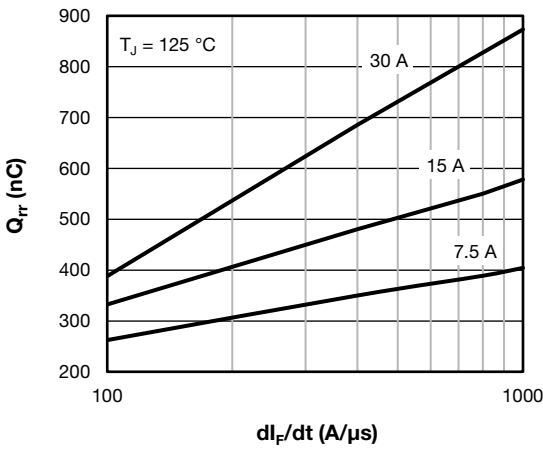


Fig. 8 - Typical Reverse Recovery Charge vs. dI_F/dt , Per Leg

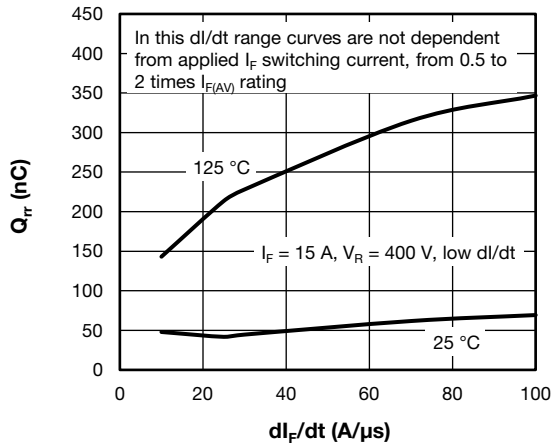


Fig. 11 - Typical Reverse Recovery Charge vs. dI_F/dt , Per Leg

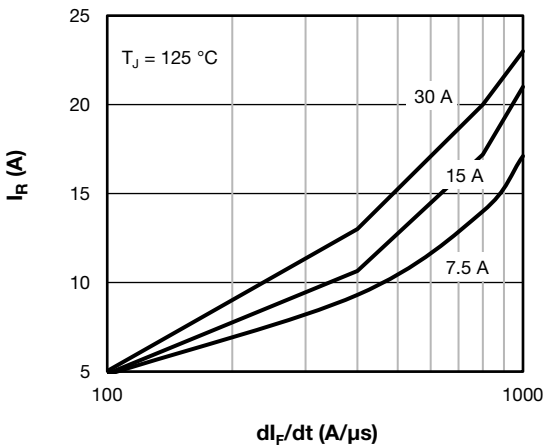


Fig. 9 - Typical Reverse Recovery Current vs. dI_F/dt , Per Leg

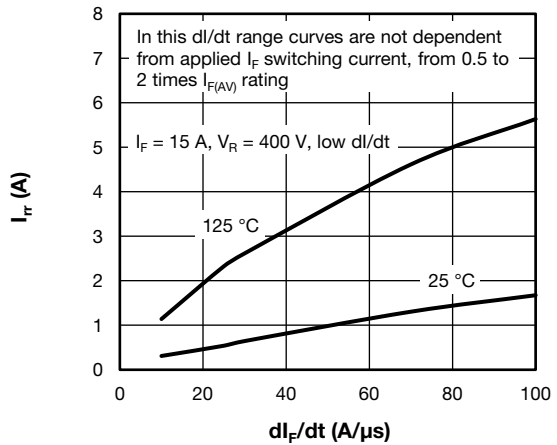


Fig. 12 - Typical Reverse Recovery Current vs. dI_F/dt , Per Leg

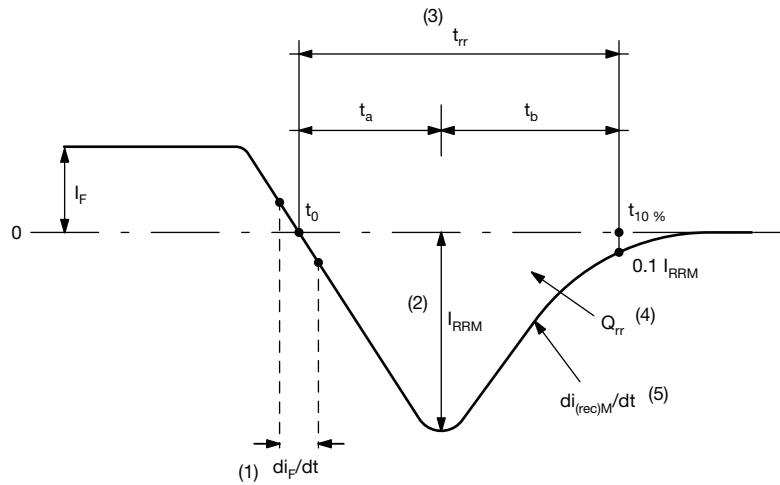


Fig. 13 - Reverse Recovery Waveform and Definitions

Notes

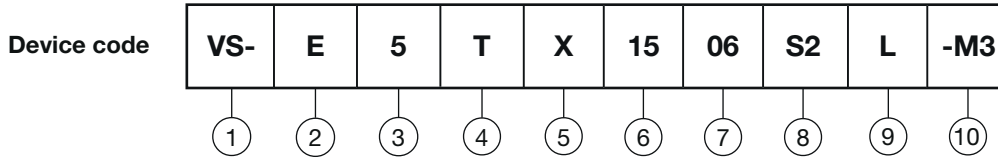
- (1) di_F/dt - rate of change of current through zero crossing
- (2) I_{RRM} - peak reverse recovery current
- (3) t_{rr} - reverse recovery time measured from t_0 , crossing point of negative going I_F , to point $t_{10\%}$, $0.1 I_{RRM}$
- (4) Q_{rr} - area under curve defined by t_0 and $t_{10\%}$

$$Q_{rr} = \int_{t_0}^{t_{10\%}} I(t) dt$$

- (5) $di_{(rec)M}/dt$ - peak rate of change of current during t_b portion of t_{rr}



ORDERING INFORMATION TABLE



- 1** - Vishay Semiconductors product
- 2** - E = single diode
- 3** - 5 = FRED generation 5
- 4** - Package:
T = D²PAK (TO-263) package
- 5** - X = hyperfast recovery
- 6** - Current rating (15 = 15 A)
- 7** - Voltage rating (12 = 1200 V)
- 8** - S2 = true 2 pin D²PAK
- 9** - None = tube (50 pieces)
• L = tape and reel (left oriented, for D²PAK package)
If needed different orientation/packaging, please contact factory
- 10** - Environmental digit:
-M3 = halogen-free, RoHS-compliant, and termination lead (Pb)-free

| ORDERING INFORMATION (Example) | | |
|--------------------------------|---------------|-----------------------|
| PREFERRED P/N | BASE QUANTITY | PACKAGING DESCRIPTION |
| VS-E5TX1506S2L-M3 | 800 | 13" diameter reel |

| LINKS TO RELATED DOCUMENTS | |
|----------------------------|--|
| Dimensions | www.vishay.com/doc?96683 |
| Part marking information | www.vishay.com/doc?96693 |
| Packaging information | www.vishay.com/doc?95032 |

D²PAK 2L (TO-263AB 2L)

DIMENSIONS in millimeters and inches

Conforms to JEDEC[®] outline D²PAK (SMD-220)



| SYMBOL | MILLIMETERS | | INCHES | | NOTES | SYMBOL | MILLIMETERS | | INCHES | | NOTES |
|--------|-------------|-------|--------|-------|-------|--------|-------------|-------|-----------|-------|-------|
| | MIN. | MAX. | MIN. | MAX. | | | MIN. | MAX. | MIN. | MAX. | |
| A | 4.06 | 4.83 | 0.160 | 0.190 | | D1 | 6.86 | 8.00 | 0.270 | 0.315 | 3 |
| A1 | 0.00 | 0.254 | 0.000 | 0.010 | | E | 9.65 | 10.67 | 0.380 | 0.420 | 2, 3 |
| b | 0.51 | 0.99 | 0.020 | 0.039 | | E1 | 7.90 | 8.80 | 0.311 | 0.346 | 3 |
| b1 | 0.51 | 0.89 | 0.020 | 0.035 | 4 | e | 2.54 BSC | | 0.100 BSC | | |
| b2 | 1.14 | 1.78 | 0.045 | 0.070 | | H | 14.61 | 15.88 | 0.575 | 0.625 | |
| b3 | 1.14 | 1.73 | 0.045 | 0.068 | 4 | L | 1.78 | 2.79 | 0.070 | 0.110 | |
| c | 0.38 | 0.74 | 0.015 | 0.029 | | L1 | - | 1.65 | - | 0.066 | 3 |
| c1 | 0.38 | 0.58 | 0.015 | 0.023 | 4 | L3 | 0.25 BSC | | 0.010 BSC | | |
| c2 | 1.14 | 1.65 | 0.045 | 0.065 | | L4 | 4.78 | 5.28 | 0.188 | 0.208 | |
| D | 8.51 | 9.65 | 0.335 | 0.380 | 2 | | | | | | |

Notes

- (1) Dimensioning and tolerancing per ASME Y14.5 M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Datum A and B to be determined at datum plane H
- (6) Controlling dimension: inch
- (7) Outline conforms to JEDEC[®] outline TO-263AB



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